2009 LIMITED LIABILITY COMPANY ANNUAL REPORT

DOCUMENT# M08000004755

Address:

City-St-Zip:

Entity Name: ELECTRONIC ASSEMBLY PRODUCTS V, LLC

FILED Apr 28, 2009 Secretary of State

Current Principal Place of Business:			New Principal	New Principal Place of Business:	
	NWOOD WAY OH 45440				
Current Mailing Address:			New Mailing Address:		
	NWOOD WAY OH 45440				
FEI Number: 26-3594088 FEI Number Applied For ()		FEI Number Not Applicabl	e () Certificate of Status Desired ()		
Name and Address of Current Registered Agent:			Name and Address of New Registered Agent:		
	ECREST AVE	NUE US			
	e named entity : e of Florida.	submits this statement for the p	ourpose of changing its re	gistered office or registered agent, or both,	
SIGNATU	RE:				
	Electror	ic Signature of Registered Age	ent	Date	
MANAGING MEMBERS/MANAGERS:			ADDITIONS/CHANGES:		
Title: Name: Address: City-St-Zip:	MGRM () DACO TECHNO 1007 RIFLECR VALRICO, FL (EST AVE	Title: Name: Address: City-St-Zip:	() Change () Addition	
Title: Name:		Delete		RM () Change (X) Addition ECTRONIC ASSEMBLY PRODUCTS SERVICES, LLC	

Address:

1707 GLENWOOD WAY

City-St-Zip: DAYTON, OH 45440

I hereby certify that the information supplied with this filing does not qualify for the exemption stated in Chapter 119, Florida Statutes. I further certify that the information indicated on this report is true and accurate and that my electronic signature shall have the same legal effect as if made under oath; that I am a managing member or manager of the limited liability company or the receiver or trustee empowered to execute this report as required by Chapter 608, Florida Statutes.

SIGNATURE: JOHN W. JOHNSON, JR. MGRM 04/28/2009